# **XPRO**

## High-Performance Rubidium Oscillator

#### **Summary**

Microchip's XPRO is a high-performance rubidium oscillator designed for a wide range of telecommunications and test and measurement applications. The XPRO is a drop-in replacement for the venerable LPRO, which has been widely installed in wireless base station applications, RF test equipment and other applications where an embedded high-performance oscillator is required.

The XPRO leverages over 35 years of proven rubidium atomic physics with advanced digital electronics architecture to provide an exceptionally stable oscillator that meets the most demanding performance requirements.

With its low profile and standard connector interface, the XPRO is designed for easy integration into time and frequency systems. Great care has been taken in the design to minimize EMI emissions and susceptibility, including the use of a filtered 9-pin D-connector, SMA for the RF output and a shielded outer cover.



The XPRO is designed for long operating periods without maintenance (long-life rubidium lamp and extended crystal control range). With a  $5.0 \times 10^{-11}$  per month aging, the oscillator will maintain  $1.0 \times 10^{-9}$  frequency accuracy for 10 years or longer without recalibration.

A low aging rate option is available for XPRO that will provide  $1 \times 10^{-11}$  per month aging, resulting in an even more robust reference source.

Standard outputs are 10 MHz, 1PPS and a rubidium lock status bit. All monitoring and control is done through the TTL level RS-232 style serial interface, allowing you access to comprehensive status and control parameters.

#### Standard Features

- 10 MHz output
- 1 PPS output
- $<5.0 \times 10^{-11}$  (optional  $<1.0 \times 10^{-11}$ ) per month aging
- Digital monitor and control
- RoHS compliant
- Low EMI emission and susceptibility

#### **Benefits**

- Low profile with standard connector interface for easy integration
- Low maintenance
- Long lifecycle (>10 years) without recalibration operation



# Specifications<sup>1</sup>

### Electrical

Liectrical		
	RF Output	
Frequency	10 MHz	
Format	Sinewave	
Amplitude	7.8 ±0.8 dBm	
Load impedance	50 Ω	
Connector	SMA	
Quantity	1	
	1PPS Output	
Rise time	<5 nS	
Pulse width	<20 μS	
Level	5V CMOS (Vh > 4.2V, 15 pF load)	
Jitter	<1 ns RMS	
Connector	DB-9	
Quantity	1	
Built-ir	Test Equipment Output	
Format	5V CMOS (Vh > 4.2V, 15 pF load)	
Logic	0 = Normal Operation 1 = Alarm	
Sei	rial Communications	
Protocol	RS-232	
Format	3.3V CMOS (not true RS-232)	
Baud rate	57,600 (8, N, 1)	
	Power Input	
Max input (A) at 24V	<1.45 A (at -20°C) <1.43 A (at 25°C)	
Input voltage range	19 VDC to 32 VDC	
Voltage sensitivity	$0.72 \times 10^{-11}$ /V (over input voltage range)	
Input power quiescent	24 VDC at 25°C <14 W 19 VDC at 65°C <9.5 W	
	Physical	
Input connector	(1) DB-9 (all input power, monitoring, 1PPS)	
RF connector	(1) SMA	
	1.5" (3.81 cm) (H) ×	
Dimensions	3.7" (9.4 cm) (W) × 5.0" (12.7 cm) (D)	
Dimensions  Weight		

'All specifications at 25C and 24 Vdc,	unless noted otherwise.
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Environmental		
Operating temperature	-25°C to 70°C baseplate	
Altitude	-200' to 40,000'	
Magnetic sensitivity	DC (≤2 Gauss), <±1.0 × 10 <sup>-11</sup> /Gauss	
Humidity	GR-63-CORE, issue 4, April 2012, section 4.1.2: 5–85% RH, operating	
Vibration (operating)	Telcordia GR-63-CORE, Issue 4, April 2012, section 4.4.4 and 5.4.2 Opt2: Random Vibration 0.15 grms, unit remains locked	
ЕМІ	Compliant to FCC Part 15 Class B (conducted and radiated emissions) and complies with EN55022B emissions (radiated and conducted) and EN50082-1 (immunity)	
Storage and	Transport (Non-operating)	
Temperature	−55°C to 85°C	
Altitude	-200' to 70,000'	
Vibration	Telcordia GR-63-CORE, Issue 4, April 2012; section 4.4.5 and 5.4.3: Random Vibration 0.78 grms	
Shock	Telcordia GR-63-CORE, Issue 4, April 2012; section 4.3.1 and 5.3.1.1: Packaged Drop from 1000 mm	
Performance Parameters		
Aging (after 1 month continuous operation)	Monthly: $<\pm5.0 \times 10^{-11}$ ; $<1.0 \times 10^{-11}$ (option) 10 years: $<\pm1.0 \times 10^{-9}$	
Frequency accuracy at shipment	<±5.0 × 10 <sup>-11</sup>	
Frequency retrace	$<\pm2.5\times10^{-11}$ (24 hours on, 48 hours off, 24 hours on)	
Analog tuning	$\pm 1.5 \times 10^{-9}  (\text{OV}-5\text{V})$	
Digital tuning	$\pm 1.0 \times 10^{-6}$ (with 1.5 × 10 <sup>-12</sup> resolution)	
Тетрсо	$<6.0 \times 10^{-10}$ (-25°C to 70°C), $<3.0 \times 10^{-10}$ (0°C to 50°C)	



#### **RF Output Phase Noise (SSB)**

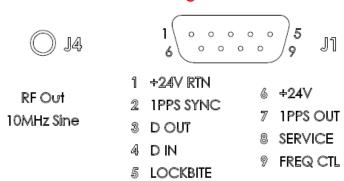
Frequency	Phase Noise
1 Hz	≤-80 dBc/Hz
10 Hz	≤-90 dBc/Hz
100 Hz	≤-128 dBc/Hz
1 kHz	≤-143 dBc/Hz
10 kHz	≤-148 dBc/Hz

Spectral purity: <-60 dBc (harmonics), <-80 dBc (non-harmonics)

#### **Frequency Stability (Allan Deviation)**

Time	Allan Deviation
TAU = 1 second	<1.0 × 10 <sup>-11</sup>
TAU = 10 seconds	<3.2 × 10 <sup>-12</sup>
TAU = 100 seconds	$<1.0 \times 10^{-12}$

### **XPRO Connection Diagram**



#### **Warm-Up Time**

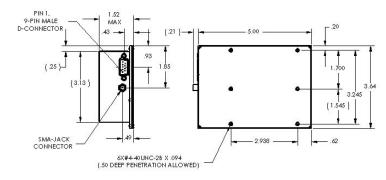
Parameter	−20°C	25°C
To lock	<8.7 minutes	<6 minutes
To $<1 \times 10^{-9}$	<10.2 minutes	<8 minutes
To $<4 \times 10^{-10}$	<12.7 minutes	<10.6 minutes

### **Ordering Information<sup>2</sup>**

Part Number	Description
16192-003	$1 \times 10^{-11}$ /month aging, AT disabled, RoHS 6/6
16192-004	$1 \times 10^{-11}$ /month aging, AT enabled, RoHS 6/6
16192-103	$5 \times 10^{-11}$ /month aging, AT disabled, RoHS 6/6
16192-104	$5 \times 10^{-11}$ /month aging, AT enabled, RoHS 6/6

 $<sup>{}^{2}</sup>AT = analog tuning.$ 

## **XPRO Outline Diagram**





#### **For More Information**

www.microsemi.com

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